

STGE50NC60WD

N-channel 50A - 600V - ISOTOP Ultra fast switching PowerMESH™ IGBT

Features

Туре	V _{CES}	V _{CE(sat)} (Max) @25°C	I _C @100°C	
STGE50NC60WD	GE50NC60WD 600V		50A	

- High current capability
- High frequency operation
- Low C_{RES}/C_{IES} ratio (no cross-conduction susceptibility
- Very soft ultra fast recovery antiparallel diode



Using the latest high voltage technology based on a patented strip layout, STMicroelectronics has designed an advanced family of IGBTs, the PowerMESH™ IGBTs, with outstanding performances. The suffix "W" identifies a family optimized for very high frequency applications.

Applications

- Very high frequency inverters
- HF, SMPS and PFC in both hard switching and resonant topologies
- UPS
- Motor drivers
- Welding

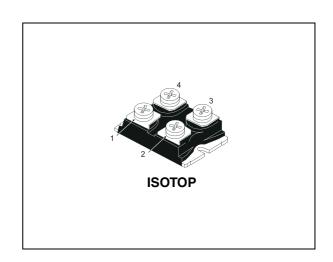


Figure 1. Internal schematic diagram

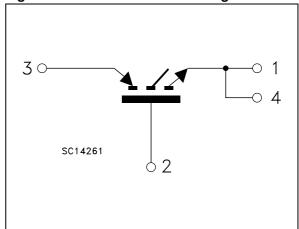


Table 1. Device summary

Order code	Marking	Package	Packaging	
STGE50NC60WD	GE50NC60WD	ISOTOP	Tube	

Contents STGE50NC60WD

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STGE50NC60WD Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{CES}	Collector-emitter voltages _{GS} = 0)	600	V
I _C ⁽¹⁾	Collector current (continuous) at T _C = 25°C	100	Α
I _C ⁽¹⁾	Collector current (continuous) at T _C = 100°C	50	Α
I _{CL} (2)	Collector current (pulsed)	250	Α
V _{GE}	Gate-emitter voltage	± 20	V
IF	Diode RMS forward current at Tc=25°C	30	Α
P _{TOT}	Total dissipation at T _C = 25°C	260	W
T _{stg}	Storage temperature	-55 to 150	°C
Tj	Operating junction temperature	-55 10 150	

^{1.} Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{T_{JMAX}^{-T}C}{R_{THJ-C}^{\times V}CESAT(MAX)^{(T_{C}, \ I_{C})}}$$

2. Pulse width limited by Tjmax

Table 3. Thermal resistance

Symbol	Parameter	Min	Тур	Max	Unit
Rthj-case	Thermal resistance junction-case (IGBT)			0.48	°C/W
Rthj-case	Thermal resistance junction-case (diode)	-		1.5	°C/W
Rthj-amb	Thermal resistance junction-amb	1	-	50	°C/W

Electrical characteristics STGE50NC60WD

2 Electrical characteristics

(T_J = 25 $^{\circ}$ C unless otherwise specified)

Table 4. Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{BR(CES)}	Collector-emitter breakdown voltage	I _C = 1mA, V _{GE} = 0	600			٧
V _{CE(sat)}	Collector-emitter saturation voltage	V _{GE} = 15V, I _C = 40A V _{GE} = 15V, I _C =40A,Tc=125°C		2.1 1.9	2.6	V V
V _{GE(th)}	Gate threshold voltage	$V_{CE} = V_{GE}, I_{C} = 250 \mu A$	3.75		5.75	V
I _{CES}	Collector cut-off current (V _{GE} = 0)	V_{CE} = Max rating, T_{C} = 25°C V_{CE} = Max rating, T_{C} = 125°C			500 5	μA mA
I _{GES}	Gate-emitter leakage current (V _{CE} = 0)	V _{GE} = ±20V, V _{CE} = 0			±100	nA
9 _{fs}	Forward transconductance	$V_{CE} = 15V_{,} I_{C} = 40A$		25		S

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{ies} C _{oes} C _{res}	Input capacitance Output capacitance Reverse transfer capacitance	$V_{CE} = 25V, f = 1MHz,$ $V_{GE} = 0$		4700 410 90		pF pF pF
Q _g Q _{ge} Q _{gc}	Total gate charge Gate-emitter charge Gate-collector charge	V_{CE} = 390V, I_{C} = 40A, V_{GE} = 15V, Figure 17		195 32 82		nC nC nC

Table 6. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	V_{CC} = 390V, I_{C} = 40A R_{G} = 3.3 Ω V_{GE} = 15V, Figure 16, Figure 18		52 17 2400		ns ns A/µs
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	V_{CC} = 390V, I_{C} = 40A R_{G} = 3.3 Ω , V_{GE} = 15V, T_{j} = 125°C Figure 16, Figure 18		50 19 2020		ns ns A/µs
t _{r(Voff)} t _{d(Voff)} t _f	Off voltage rise time Turn-off delay time Current fall time	V_{CC} = 390V, I_{C} = 40A R_{G} = 3.3 Ω V_{GE} = 15V, Figure 16, Figure 18		31 240 35		ns ns ns
t _{r(Voff)} t _{d(Voff)} t _f	Off voltage rise time Turn-off delay time Current fall time	V_{CC} = 390V, I_{C} = 40A R_{G} = 3.3 Ω V_{GE} = 15V, T_{J} = 125°C Figure 16, Figure 18		59 280 63		ns ns ns

Table 7. Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
E _{on} ⁽¹⁾ E _{off} ⁽²⁾ E _{ts}	Turn-on switching losses Turn-off switching losses Total switching losses	V_{CC} = 390V, I_{C} = 40A R_{G} = 3.3 Ω , V_{GE} = 15V, Figure 18		365 560 925	470 790 1260	μJ μJ μJ
E _{on} ⁽¹⁾ E _{off} ⁽²⁾ E _{ts}	Turn-on switching losses Turn-off switching losses Total switching losses	V_{CC} = 390V, I_{C} = 40A R_{G} = 3.3 Ω V_{GE} = 15V, T_{J} = 125°C Figure 18		635 910 1545		μJ μJ μJ

Eon is the tun-on losses when a typical diode is used in the test circuit in *Figure 18* If the IGBT is offered in a package with a co-pak diode, the co-pack diode is used as external diode. IGBTs & Diode are at the same temperature (25°C and 125°C)

^{2.} Turn-off losses include also the tail of the collector current

Electrical characteristics STGE50NC60WD

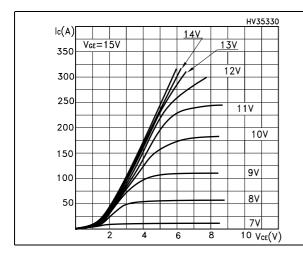
Table 8. Collector-emitter diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _f	Forward on-voltage	I _f = 15A I _f = 15A, Tj = 125°C I _f = 40A, Tj = 125°C		1.5 1.2 1.35	2.9	V V V
t _{rr} Q _{rr} I _{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_f = 40A, V_R = 50V,$ $Tj = 25$ °C, $di/dt = 100 A/\mu s$ Figure 19		55 100 3.6		ns nC A
t _{rr} Q _{rr} I _{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	I _f = 40A,V _R = 50V, Tj =125°C, di/dt = 100A/μs <i>Figure 19</i>		164 525 6.4		ns nC A

2.1 Electrical characteristics (curves)

Figure 2. Output characteristics

Figure 3. Transfer characteristics



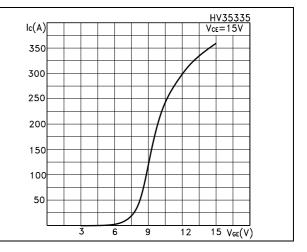
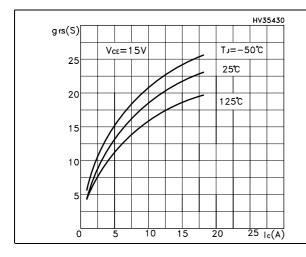


Figure 4. Transconductance

Figure 5. Collector-emitter on voltage vs temperature



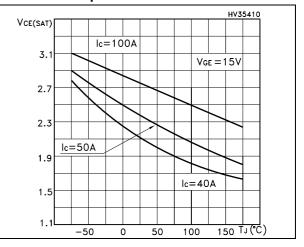
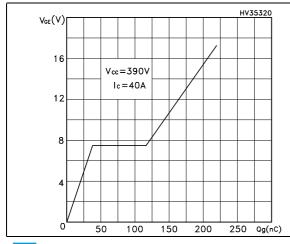
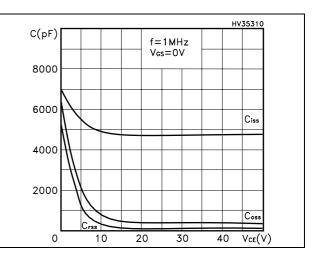


Figure 6. Gate charge vs gate-source voltage Figure 7. Capacitance variations





Electrical characteristics STGE50NC60WD

Figure 8. Normalized gate threshold voltage Figure 9. Collector-emitter on voltage vs vs temperature collector current

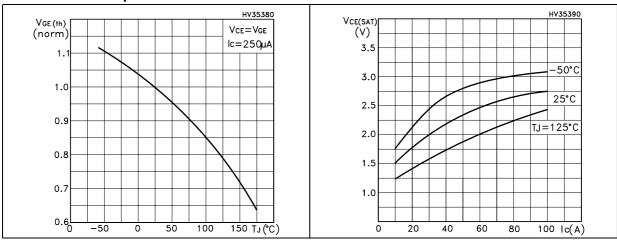


Figure 10. Normalized breakdown voltage vs Figure 11. Switching losses vs temperature temperature

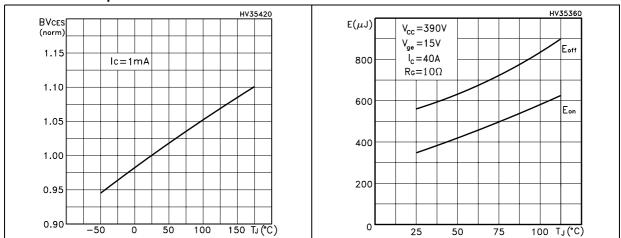
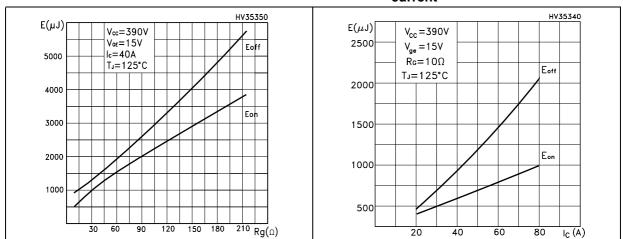


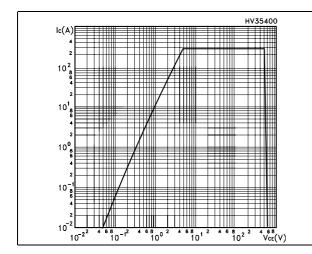
Figure 12. Switching losses vs gate resistance Figure 13. Switching losses vs collector current

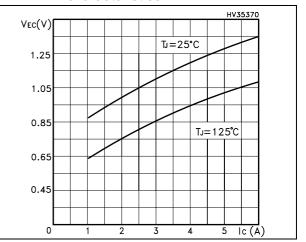


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Figure 14. Turn-off SOA

Figure 15. Emitter-collector diode characteristics





Test circuit STGE50NC60WD

3 Test circuit

Figure 16. Test circuit for inductive load switching

Figure 17. Gate charge test circuit

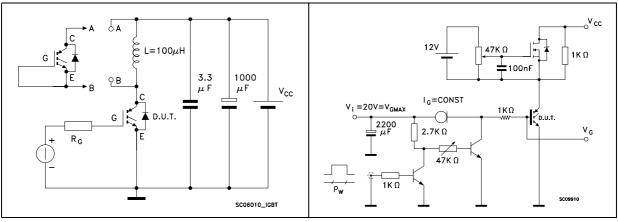
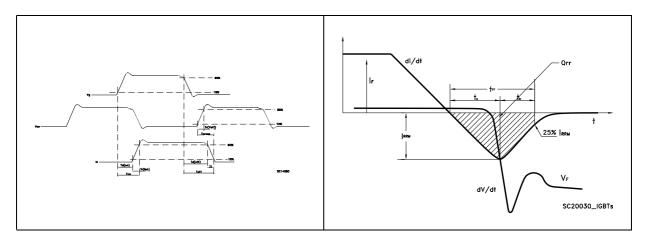


Figure 18. Switching waveform

Figure 19. Diode recovery time waveform

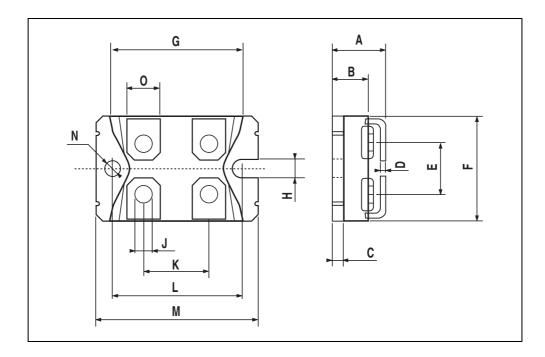


4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

ISOTOP MECHANICAL DATA

DIM.		mm			inch	
DIIVI.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
Α	11.8		12.2	0.466		0.480
В	8.9		9.1	0.350		0.358
С	1.95		2.05	0.076		0.080
D	0.75		0.85	0.029		0.033
E	12.6		12.8	0.496		0.503
F	25.15		25.5	0.990		1.003
G	31.5		31.7	1.240		1.248
Н	4			0.157		
J	4.1		4.3	0.161		0.169
K	14.9		15.1	0.586		0.594
L	30.1		30.3	1.185		1.193
М	37.8		38.2	1.488		1.503
N	4			0.157		
0	7.8		8.2	0.307		0.322



STGE50NC60WD Revision History

5 Revision History

Table 9. Revision history

Date	Revision	Changes	
07-May-2006	1	First release	
24-Jul-2007	2	New Figure 1: Internal schematic diagram	

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Contact Us:

> Address:

401 Building No.5, JiuGe Business Center, Lane 2301, Yishan Rd Minhang District, Shanghai , China

> Sales:

Direct +86 (21) 6401-6692

Email amall@ameya360.com

QQ 800077892

Skype ameyasales1 ameyasales2

Customer Service :

Email service@ameya360.com

Partnership :

Tel +86 (21) 64016692-8333

Email mkt@ameya360.com